

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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2SK3748

ON Semiconductor®

http://onsemi.com

N-Channel Power MOSFET 1500V, 4A, 7Ω , TO-3PF-3L

Features

- · Low ON-resistance, low input capacitance, ultrahigh-speed switching
- High reliability (Adoption of HVP process)
- · Attachment workability is good by Mica-less package
- · Avalanche resistance guarantee

Specifications

Absolute Maximum Ratings at Ta=25°C

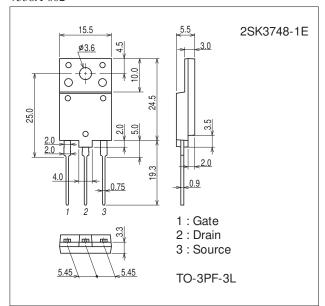
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		1500	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID*		4	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	8	Α
Allewahle Dewer Dissipation	D-		3.0	W
Allowable Power Dissipation	PD	Tc=25°C	65	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		165	mJ
Avalanche Current *2	IAV		4	Α

^{*}Shows chip capability

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ) 7538A-002



Product & Package Information

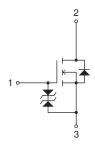
Package : TO-3PF-3LJEITA, JEDEC : SC-94

• Minimum Packing Quantity: 30 pcs./magazine

Marking

Electrical Connection





^{*1} V_{DD}=50V, L=20mH, I_{AV}=4A (Fig.1)

^{*2} L≤20mH, single pulse

Electrical Characteristics at Ta=25°C

Parameter	Symbol	mbol Conditions	Ratings			Linit	
Parameter	Symbol	Conditions	min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	1500			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =1200V, V _{GS} =0V			100	μΑ	
Gate-to-Source Leakage Current	IGSS	V _{GS} =16V, V _{DS} =0V			±10	μΑ	
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	2.5		3.5	V	
Forward Transfer Admittance	yfs	V _{DS} =20V, I _D =2A	1.7	2.8		S	
Static Drain-to-Source On-State Resistance	R _{DS} (on)	I _D =2A, V _{GS} =10V		5	7	Ω	
Input Capacitance	Ciss			790		pF	
Output Capacitance	Coss	V _{DS} =30V, f=1MHz		140		pF	
Reverse Transfer Capacitance	Crss			70		рF	
Turn-ON Delay Time	t _d (on)			17		ns	
Rise Time	t _r	Con Fig 0		75		ns	
Turn-OFF Delay Time	t _d (off)	See Fig.2		360		ns	
Fall Time	tf			116		ns	
Total Gate Charge	Qg			80		nC	
Gate-to-Source Charge	Qgs	$V_{DS}=200V$, $V_{GS}=10V$, $I_{D}=4A$		6.4		nC	
Gate-to-Drain "Miller" Charge	Qgd			36		nC	
Diode Forward Voltage	V _{SD}	I _S =4A, V _{GS} =0V		0.94	1.2	V	
Reverse Recovery Time	t _{rr}	I _S =4A, V _G S=0V, dis/dt=100A/μs		340		ns	

Fig.1 Avalanche Resistance Test Circuit

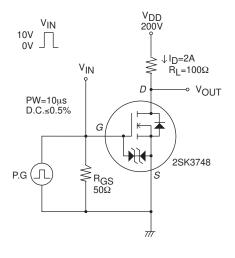
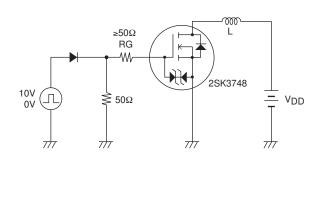
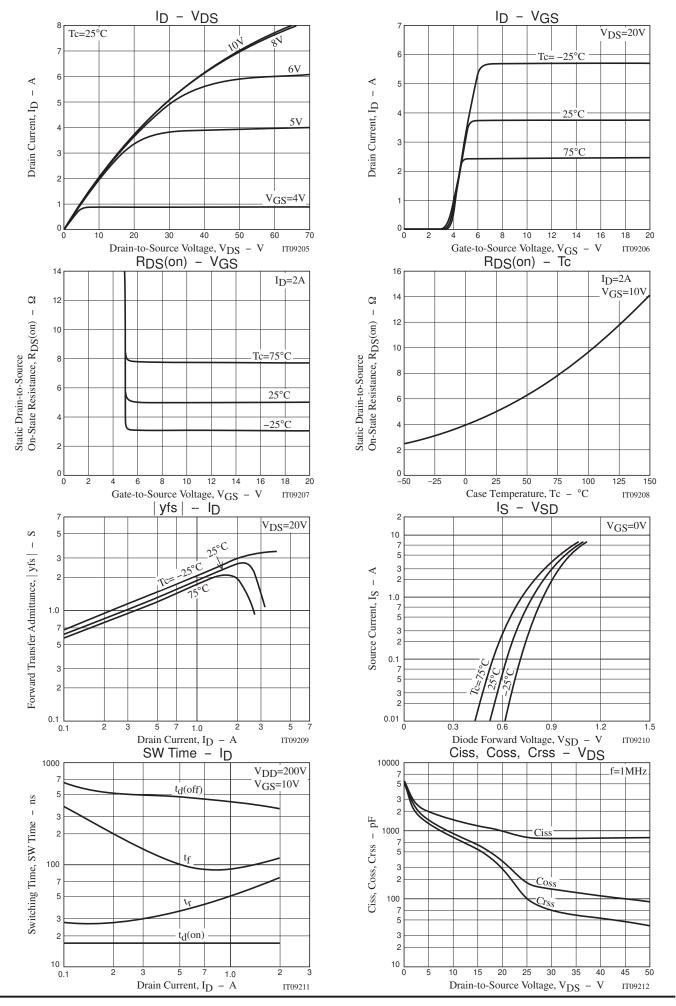


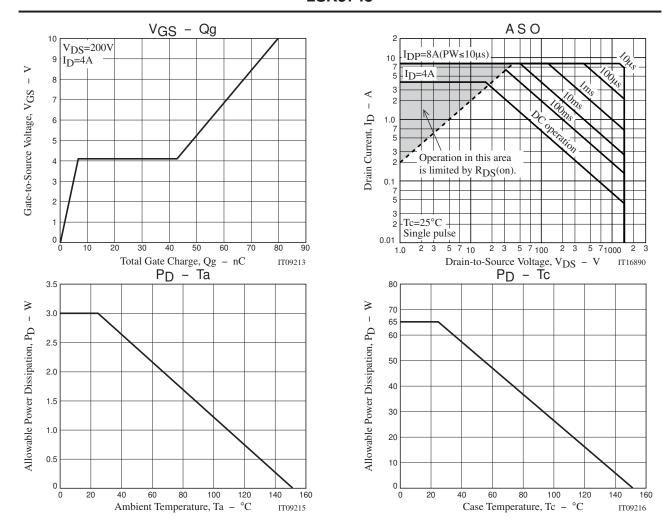
Fig.2 Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
2SK3748-1E	TO-3PF-3L	30pcs./magazine	Pb Free



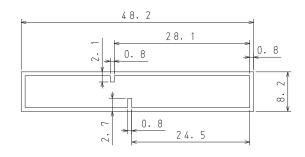


Magazine Specification

2SK3748-1E

1. Packing Format

Package Name		Maximum Number of devices contained (pcs)			Packing format		
		Magazine	Inner box	Outer box	Inner BOX	Outer BOX	
TO-3	PF-3L	30	360	1440	SPD-0V0001 12 magazines contained Dimensions:mm(external) 568×150×55	SPD-LV0010 4 inner boxes contained Dimensions:mm (external) 590x225x178	



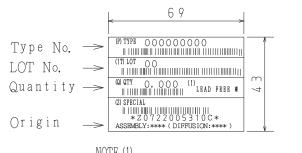
Tolerance=±0.2mm
Thickness=0.8±0.2mm
Length =508.0±1mm
Material =PVC or PET
(Antistatic treatment)

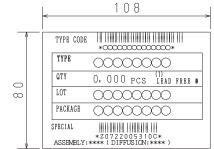
3. Storage method to magazine



- 4. Inner box label (unit:mm)
- 5. Outer box label (unit:mm)

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



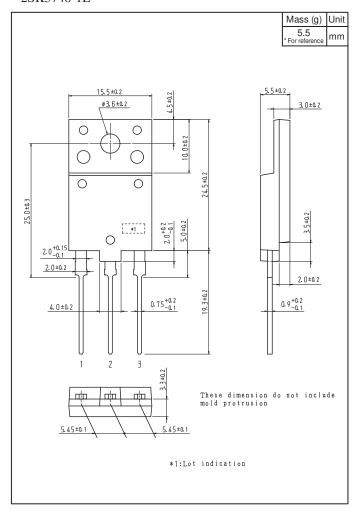


The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

Label		JEITA Phase			
LEAD FRE	E 3	JEITA Phase 3A			

Outline Drawing

2SK3748-1E



Note on usage: Since the 2SK3748 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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